

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	210	faris near sadeg	US_PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:42
S2	6	("5786629") or ("6257564") or ("5534073").PN.	US_PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/10/01 08:36
S3	2	"5967577"	US_PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/10/01 08:36
S4	7	("3404845" "4049484" "4787290" "5243841" "5284287" "5516125" "5749614").PN.	USPAT	OR	ON	2003/10/01 08:37
S5	4	("2247623" "3138508" "3377096" "3926710").PN.	USPAT	OR	ON	2003/10/01 08:38
S6	19	"4049484".URPN.	USPAT	OR	ON	2003/10/01 08:39
S7	8	("2953808" "3523707" "3631796" "3743340" "4049484" "4674785" "4712784" "4799722").PN.	USPAT	OR	ON	2003/10/01 08:40
S8	1	"2953808".PN.	USPAT	OR	ON	2003/10/01 08:41
S9	7	"4799722".URPN.	USPAT	OR	ON	2003/10/01 08:41
S10	11	("1575892" "2852253" "2984398" "3137390" "3334896" "3421753" "3504910" "3617048" "3815762" "4216955" "4327906").PN.	USPAT	OR	ON	2003/10/01 08:42
S11	7	"4881770".URPN.	USPAT	OR	ON	2003/10/01 08:43
S12	12	("2964007" "3226255" "3910621" "4506820" "4739919" "4745679" "4787662" "4881770" "5284287" "5749614" "5834062" "5839641").PN.	USPAT	OR	ON	2003/10/01 08:43
S13	6	("1842383" "3556578" "4352440" "4452557" "4479298" "4703966").PN.	USPAT	OR	ON	2003/10/01 08:50
S14	0	"5967577".URPN.	USPAT	OR	ON	2003/10/01 08:46
S15	0	"5967577".URPN.	USPAT	OR	ON	2003/10/01 08:46

S16	0	"45121".URPN.	USPAT	OR	ON	2003/10/01 08:46
S17	0	"45121".URPN.	USPAT	OR	ON	2003/10/01 08:46
S18	1365	(294/64.1).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/10/01 09:28
S19	3	("3893881" "5177857" "6173648").PN.	USPAT	OR	ON	2003/10/01 08:52
S20	2	"6336492".URPN.	USPAT	OR	ON	2003/10/01 08:53
S21	20	("3221910" "3831992" "4461328" "4468974" "4478094" "4500247" "4565100" "4604024" "4852620" "4909992" "4952518" "5063790" "5192511" "5293179" "5334352" "5343909" "5392914" "5497670" "5736105" "5807524").PN.	USPAT	OR	ON	2003/10/01 08:54
S22	12	("2964007" "3226255" "3910621" "4506820" "4739919" "4745679" "4787662" "4881770" "5284287" "5749614" "5834062" "5839641").PN.	USPAT	OR	ON	2003/10/01 08:56
S23	3	("4131267" "4684113" "4693458").PN.	USPAT	OR	ON	2003/10/01 08:59
S24	3	("3102751" "3865420" "4047532").PN.	USPAT	OR	ON	2003/10/01 09:03
S25	1	"4846517".URPN.	USPAT	OR	ON	2003/10/01 09:03
S26	9	("1945481" "2694337" "2782574" "2814233" "2895706" "3107078" "3180608" "4448404" "4468017").PN.	USPAT	OR	ON	2003/10/01 09:05
S27	16	"4721462".URPN.	USPAT	OR	ON	2003/10/01 09:06
S28	3	("3523707" "3888725" "4375126").PN.	USPAT	OR	ON	2003/10/01 09:09
S29	9	"4452557".URPN.	USPAT	OR	ON	2003/10/01 09:09
S30	13	"2572640".URPN.	USPAT	OR	ON	2003/10/01 09:16
S31	273	(239/553.5).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/10/01 09:34

S32	491	(156/538).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/10/01 09:35
S33	6	("5967577"); or ("6336492"); or ("5564682");:PN	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/27 10:06
S34	0	bunding and carrying and (shoulder near sash)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/05/05 10:59
S35	0	bunding and carrying and (sash)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/05/05 10:59
S36	1	bundling and carrying and (shoulder near sash)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/05/05 11:01
S37	167	(294/152).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/05/05 11:01
S38	100	(294/64.3).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/27 21:27
S39	64	(294/64.2).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/27 21:27
S40	1	silicon and (vaccum near suction)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:43

S41	0	(semiconductor near material) and (vacuum near suction)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:43
S42	1	(semiconductor near material) and (vacuum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:44
S43	1	(semiconductor near materials) and (vacuum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:45
S44	3	(semiconductor same material) and (vacuum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:51
S45	0	(Si-oxide) and (vacuum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:52
S46	2	(Si-oxide) and (vacuum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:53
S47	6192	(Silicon) and (vacuum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 23:04
S48	159	(Silicon) and (vacuum near system) and (vacuum near suction)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:54
S49	1	S48 and "294"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 23:04
S50	8	S48 and "414"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:55

S51	2258	(Silicon S-oxide) and (vacuum near system) and body	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 23:04
S52	2	S51 and "294"/\$.ccis	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 23:04